FAIRCHILE

30V P-Channel PowerTrench[®] MOSFET

General Description

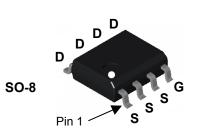
This P-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 25V).

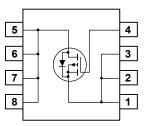
Applications

- Power management
- Load switch
- Battery protection

Features

- -5.3 A, -30 V $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$ $R_{DS(ON)} = 80 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Low gate charge
- · Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





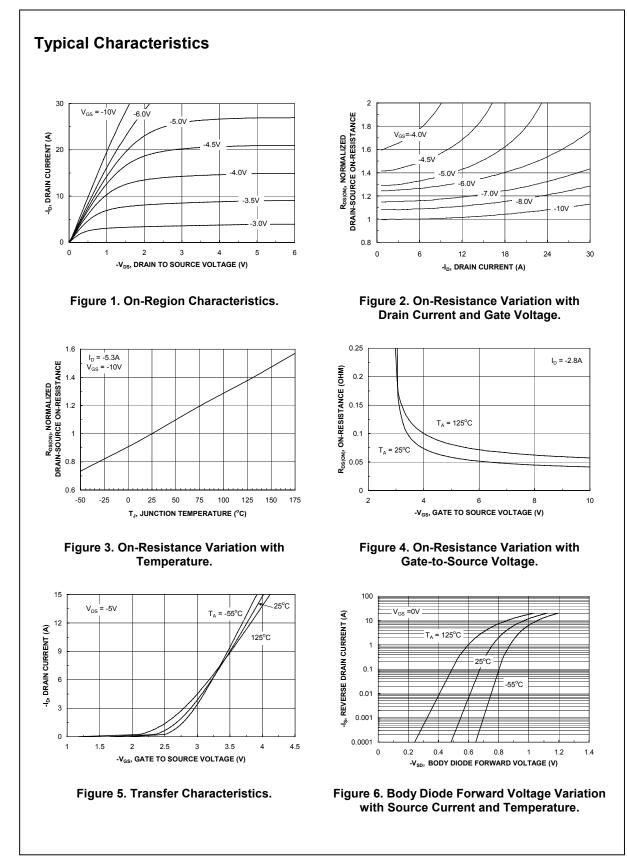
Absolute Maximum Ratings TA=25°C unless otherwise noted

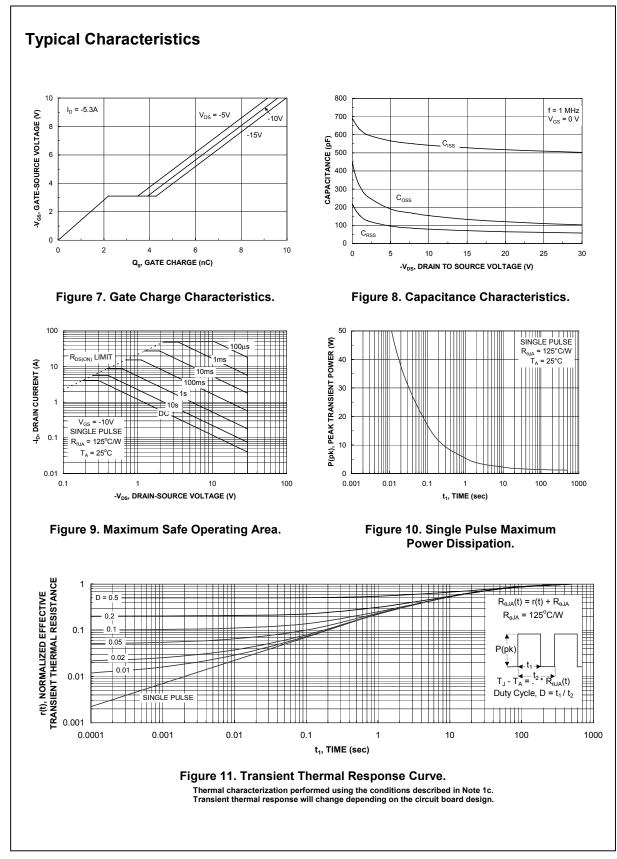
Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Sour	ce Voltage		-30	V	
V _{GSS}	Gate-Sourc	e Voltage	±25	V		
ID	Drain Curre	nt – Continuous	(Note 1a)	-5.3	А	
		– Pulsed		-50		
P _D	Power Dissipation for Single Operation		0N (Note 1a)	2.5	W	
			(Note 1b)	1.2		
			(Note 1c)	1		
T _J , T _{STG}	Operating a	ting and Storage Junction Temperature Range		–55 to +175	°C	
Therma R _{0JA}	I Charac	teristics sistance, Junction-to-Amb	Dient (Note 1a)	50	°C/W	
R _{eJA}	Thermal Resistance, Junction-to-Ambient (Note 1c)			125	°C/W	
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)			25 °C		
Packag	e Markin	g and Ordering	Information			
Device Marking		Device	Reel Size	Tape width	Quantity	
NDS9435A		NDS9435A	13"	12mm	2500 units	

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-30		[V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-23		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V$, $V_{GS} = 0 V$			-1	μA
IGSSF	Gate-Body Leakage, Forward	$V_{GS} = 25 V$, $V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -25 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.7	-3	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		4.5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -10 \ V, I_D = -5.3 \ A \\ V_{GS} = -4.5 \ V, I_D = -4 \ A \\ V_{GS} = -10 \ V, \ I_D = -5.3 \ A, \ T_J = 125^\circ C \end{array} $		42 65 57	50 80 77	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-25			Α
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -5.3 A$		10		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$			528		pF
Coss	Output Capacitance	f = 1.0 MHz		132		pF
Crss	Reverse Transfer Capacitance			70		pF
						F.
	Ig Characteristics (Note 2)			7	14	
t _{d(on)}	Turn–On Delay Time			-	24	ns
t _r	Turn–On Rise Time			13		ns
t _{d(off)}	Turn–Off Delay Time	-		14	25	ns
t _f	Turn–Off Fall Time			9	17	ns
Q _g	Total Gate Charge	$V_{DS} = -15 V$, $I_D = -4 A$, $V_{GS} = -10 V$		10	14	nC
Q _{gs}	Gate–Source Charge	VGS 10 V		2.2		nC
Q_{gd}	Gate-Drain Charge			2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source Diode Forward Current				-2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -2.1 A$ (Note 2)		-0.8	-1.2	V
otes: R _{eJA} is the sur	Voltage	mal resistance where the case thermal reference i		as the sold	ler mounting	g surfac





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